

3-Channel Enhanced High-Performance Digital Isolator

Features

- 150-Mbps Data Rate
- 5-kV RMS Isolation Rating (WSOP)
- $\pm 200\text{-kV}/\mu\text{s}$ typ Static CMTI, $\pm 150\text{-kV}/\mu\text{s}$ typ Dynamic CMTI
- Low Power Consumption, typ 3 mA/ch @1 Mbps
- Low Propagation Delay: 12 ns Typical
- Default Output Low (TPT773xF) and High (TPT773x)
- Wide Temperature Range: -40°C to $+125^\circ\text{C}$
- SOP16, QSOP16, and WSOP16 Packages
- Robust Electromagnetic Compatibility (EMC)
 - Low Emissions
 - System Level ESD, EFT, and Surge Immunity
- Safety-Related Certifications:
 - VDE Certification according to DIN VDE V 0884-17(IEC60747-17)
 - 5000-V_{RMS} (WSOP16), 3750-V_{RMS} (SOP16, QSOP16) Isolation Rating per UL 1577
 - CQC Certification per GB 4943.1
 - CSA, TUV, and CB Certifications

Description

The TPT773x devices are high-performance, 4-channel digital isolators with 5000-V_{RMS} (WSOP16), and 3750-V_{RMS} (SOP16, QSOP16) isolation ratings per UL 1577. These devices are also to be certified by VDE, UL, CSA, TUV, CQC, and CB.

The TPT773x devices provide high reliability and high performance at low power consumption with isolating digital input and output. Each isolation signal channel is separated by a double capacitive silicon dioxide insulation barrier. The TPT7730 device has three channels in the same direction while the TPT7731 device has two channels in the forward direction and one channel in the opposite direction. In the event of input power or signal loss, the default output is low for devices with the suffix F and high for devices without the suffix F.

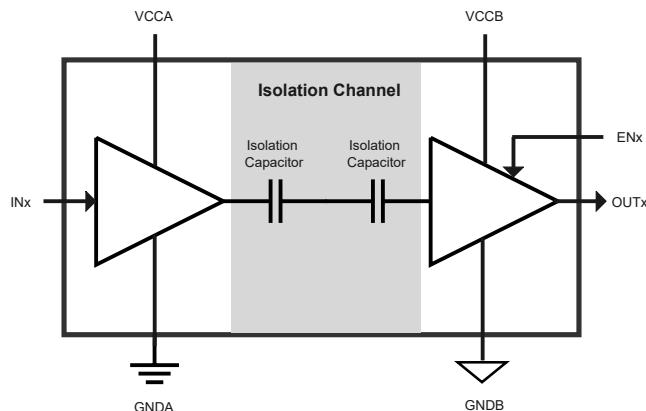
The common mode transient immunity (CMTI) and electromagnetic compatibility of the TPT773x devices have been significantly enhanced through innovative circuit design and optimized structure.

The TPT773x family is available in SOP16, QSOP16, and WSOP16 packages, and is characterized from -40°C to $+125^\circ\text{C}$.

Applications

- Industrial Automation
- Motor Control
- Power Supplies
- Isolated Interface and General-Purpose Isolation

Functional Block Diagram



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TPT773x

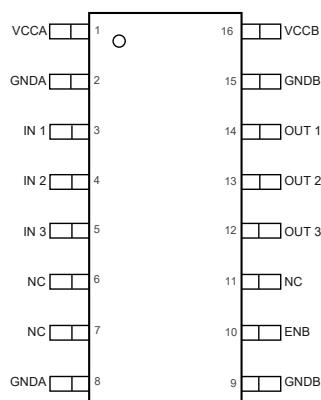
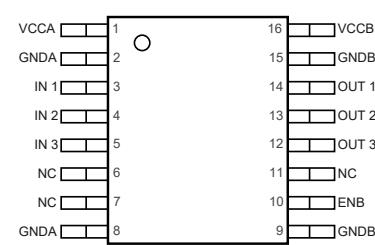
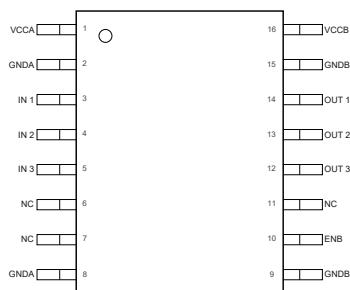
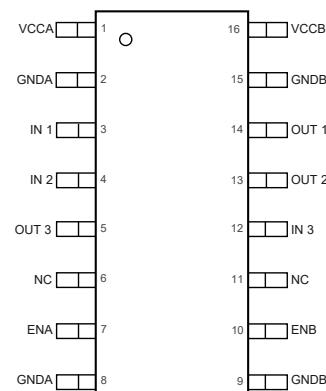
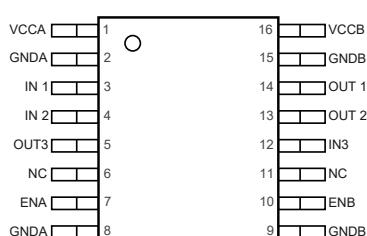
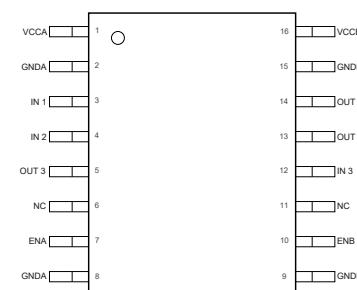
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Revision History

Date	Revision	Notes
2021-08-02	Rev.Pre.0	Initial Version
2022-12-20	Rev.A.0	Released Version

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Pin Configuration and Functions

TPT7730
SOP16
Top View

TPT7730
QSOP16
Top View

TPT7730
WSOP16
Top View

TPT7731
SOP16
Top View

TPT7731
QSOP16
Top View

TPT7731
WSOP16
Top View


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Table 1. Pin Functions: TPT773x

Pin		Name	I/O	Description
TPT7730	TPT7731			
1	1	VCCA	-	Power supply, VCCA
2	2	GNDA	-	Ground connection for VCCA
3	3	IN1	I	Input, channel 1
4	4	IN2	I	Input, channel 2
5	5	IN3	I	Input, channel 3
6, 7, 11	6, 11	NC		No connect
-	7	ENA	I	Side A enable pin
8	8	GNDA	-	Ground connection for VCCA
9	9	GNDB	-	Ground connection for VCCB
10	10	ENB	I	Side B enable pin
12	12	OUT3	O	Output, channel 3
13	13	OUT2	O	Output, channel 2
14	14	OUT1	O	Output, channel 1
15	15	GNDB	-	Ground connection for VCCB
16	16	VCCB	-	Power supply, VCCB

(1) ENA: Side A OUTx enable when ENA = high or open, and in high-impedance state when ENA is low.

(2) ENB: Side B OUTx enable when ENB = high or open, and in high-impedance state when ENB is low.

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Specifications

Absolute Maximum Ratings (1)

Parameter		Min	Max	Unit
V _{CC}	Supply Voltage, V _{CCA} , V _{CCB}	-0.5	6	V
V _{IO}	Voltage at IN _x , OUT _x , EN _x	-0.5	V _{CC} + 0.5	V
I _O	Output Current	-15	15	mA
T _J	Operating Virtual Junction Temperature	-	150	°C
T _{stg}	Storage Temperature	-65	150	°C

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. Exposure to any Absolute Maximum Rating condition for extended periods may affect device reliability and lifetime.

(2) This data was taken with the JEDEC low effective thermal conductivity test board.

(3) This data was taken with the JEDEC standard multilayer test boards.

ESD, Electrostatic Discharge Protection

Parameter	Condition	Value	Unit
HBM, per ANSI/ESDA/JEDEC JS-001/ANSI/ESD STM5.5.1 (1)	All Pin	±8	kV
CDM, per ANSI/ESDA/JEDEC JS-002 (2)	All Pin	±2	kV
Latch up, per JESD78	All Pin	±600	mA

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

Recommended Operating Conditions

Parameter		Min	Typ	Max	Unit
V _{CCX}	Supply Voltage, V _{CCA} , V _{CCB} (1)	2.25	-	5.5	V
V _{CC(UVLO+)}	UVLO threshold when supply voltage is rising (2)	-	2	2.25	V
V _{CC(UVLO+)}	UVLO threshold when supply voltage is falling (2)	1.7	1.85	-	V
V _{HYS(UVLO)}	Supply Voltage UVLO Hysteresis	60	150	-	mV
I _{OH}	High-Level Output Current	V _{CCB} = 5 V	-4	-	mA
		V _{CCB} = 3.3 V	-2	-	mA
		V _{CCB} = 2.5 V	-1	-	mA
I _{OL}	High-Level Output Current	V _{CCB} = 5 V	-	-	4 mA
		V _{CCB} = 3.3 V	-	-	2 mA
		V _{CCB} = 2.5 V	-	-	1 mA
V _{IH}	High-Level Input Voltage (data input)	2	-	V _{CC}	V
V _{IL}	Low-Level Input Voltage (data input)	0	-	0.8	V
f _{data}	Data Rate (3)	0	-	150	Mbps
T _A	Operating Ambient Temperature	-40	25	125	°C

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- (1) V_{CCA} is input side V_{CC} ; V_{CCB} is output side V_{CC} ;
 (2) $V_{CC(UVLO+)}$, $V_{CC(UVLO+)}$, $V_{HYS(UVLO)}$ are same to V_{CCA} and V_{CCB} ;
 (3) 150 Mbps is the data rate tested in lab, although higher data rates are possible.

Thermal Information

Package Type	θ_{JA}	θ_{JC}	Unit
SOP16	79	31	°C/W
QSOP16	112	58	°C/W
WSOP16	93	52	°C/W

Insulation Specifications

Parameter	Conditions	Value			Unit
		SOP16	QSOP16	WSOP16	
CLR	External clearance	Shortest terminal-to-terminal distance through air	> 4.0	> 4.0	> 8.0
CPG	External creepage	Shortest terminal-to-terminal distance across the package surface	> 4.0	> 4.0	> 8.0
DTI	Distance through the insulation	Minimum internal gap (internal clearance)	> 22	> 22	> 22
DTC	Distance through the Molding compound	Minimum internal distance across the conductors inside the package	0.45	0.45	0.8
CTI	Comparative tracking index		> 600	> 600	> 600
	Material group		I	I	I
	Over-voltage category	For Rated Mains Voltage $\leq 150 V_{RMS}$	I-IV	I-IV	I-IV
		For Rated Mains Voltage $\leq 300 V_{RMS}$	I-III	I-III	I-IV
		For Rated Mains Voltage $\leq 600 V_{RMS}$	I-II	I-II	I-IV
		For Rated Mains Voltage $\leq 1000 V_{RMS}$	I	I	I-III
	Climatic category		40/125/21	40/125/21	40/125/21
	Pollution degree		2	2	2

DIN V VDE V 0884-17 (1)(2)

V_{IORM}	Maximum repetitive isolation voltage	AC voltage	637	637	1414	V_{PK}
V_{IOWM}	Maximum working isolation voltage	AC voltage; TDDB Test	450	450	1000	V_{RMS}
		DC voltage	637	637	1414	V_{DC}
V_{IOTM}	Maximum transient isolation voltage	$V_{TEST} = V_{IOTM}$, $t = 60$ s (qualification); $V_{TEST} = 1.2 \times V_{IOTM}$, $t = 1$ s (100% production)	5300	5300	7070	V_{PK}

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Parameter		Conditions	Value			Unit
			SOP16	QSOP16	WSOP16	
V_{IOSM}	Maximum surge isolation voltage ⁽³⁾	Test method per IEC 62368-1, 1.2/50 μ s waveform, $V_{TEST} = 1.3 \times V_{IOSM}$ (qualification)	5980	5980	6500	V_{PK}
q_{pd}	Apparent charge	Method a, After Input/Output safety test subgroup 2/3, $V_{ini} = V_{IOTM}$, $t_{ini} = 60$ s; $V_{pd(m)} = 1.2 \times V_{IORM}$, $t_m = 10$ s	≤ 5	≤ 5	≤ 5	pC
		Method a, After environmental tests subgroup 1, $V_{ini} = V_{IOTM}$, $t_{ini} = 60$ s; $V_{pd(m)} = 1.6 \times V_{IORM}$, $t_m = 10$ s	≤ 5	≤ 5	≤ 5	
		Method b1; At routine test (100% production) and preconditioning (type test), $V_{ini} = 1.2 \times V_{IOTM}$, $t_{ini} = 1$ s; $V_{pd(m)} = 1.875 \times V_{IORM}$, $t_m = 1$ s	≤ 5	≤ 5	≤ 5	
C_{IO}	Isolation capacitance	$V_{IO} = 0.4 \times \sin(2\pi ft)$, $f = 1$ MHz	~ 0.5	~ 0.5	~ 0.5	pF
R_{IO}	Isolation resistance	$V_{IO} = 500$ V, $T A = 25^\circ C$	$> 10^{12}$	$> 10^{12}$	$> 10^{12}$	Ω
		$V_{IO} = 500$ V, $100^\circ C \leq T A \leq 125^\circ C$	$> 10^{11}$	$> 10^{11}$	$> 10^{11}$	Ω
		$V_{IO} = 500$ V at $T S = 150^\circ C$	$> 10^9$	$> 10^9$	$> 10^9$	Ω
UL 1577						
V_{ISO}	Withstanding isolation voltage	$V_{TEST} = V_{ISO}$, $t = 60$ s (qualification); $V_{TEST} = 1.2 \times V_{ISO}$, $t = 1$ s (100% production)	3750	3750	5000	V_{RMS}

(1) All pins on each side of the barrier are tied together creating a two-terminal device.

(2) This coupler is suitable for safe electrical insulation only within the safety operating ratings. Compliance with the safety ratings shall be ensured by means of suitable protective circuits.

(3) Testing must be carried out in oil.

3-Channel Enhanced High-Performance Digital Isolator
Safety-Related Certifications

VDE	UL	TUV	CQC	CSA	CB
Certified according to DIN VDE V 0884-17	Certified according to UL 1577 and CSA Component Acceptance Notice 5A	Certified according to EN IEC 62368-1 and EN IEC 61010-1	Certified according to GB 4943.1	Certified CSA C22.2 No. 62368-1 and CAN/CSA-C22.2 No. 60601-1	Certified according to EN IEC 62368-1
Basic insulation (WSOP) VIORM= 1414 VIOSM= 6500 (SOP, QSOP) VIORM= 637 VIOSM= 5980	(WSOP)Single protection, 5000Vrms (SOP, QSOP)Single protection, 3750Vrms	6400Vrms reinforced insulation (WSOP), 800Vrms maximum work voltage. 4000Vrms basic insulation (SOP, QSOP), 400V rms maximum work voltage.	Reinforced insulation (WSOP), Altitude<=5000m, 800V rms maximum work voltage. Basic insulation (SOP, QSOP), Altitude<=5000m, 400V rms maximum work voltage.	400Vrms basic insulation (SOP, QSOP) and 600V rms reinforced insulation (WSOP) working voltage per CSA C22.2 No. 62368-1:19 3rd, IEC 62368-1:2018 Ed. 3(in pollution degree 2, material group I) 2 MOPP (Means of Patient Protection) insulation requirements for 250Vrms (WSOP) in CAN/CSA-C22.2 No. 60601-1:14, IEC 60601-1:2005 + AMD1:2012	Reinforced insulation (WSOP), Altitude<=5000m, 800V rms maximum work voltage. Basic insulation (SOP, QSOP), Altitude<=5000m, 400V rms maximum work voltage.
Certificate No. 40054570	Report Reference E524241	Customer No. 2332359	Certificate No. CQC22001332218 CQC22001332219 CQC22001356662	Master contract: 302375	Ref. Certif. No. CN56354 CN56355 CN57659

3-Channel Enhanced High-Performance Digital Isolator
Safety Limiting Values

Parameter	Conditions ⁽¹⁾	Min	Typ	Max	Unit
Safety Supply Current	$R_{\theta JA} = 79^\circ\text{C}/\text{W}$, $V_I = 5 \text{ V}$, $T_J = 150^\circ\text{C}$, $T_A = 25^\circ\text{C}$ (SOP16)	-	-	316.4	mA
	$R_{\theta JA} = 112^\circ\text{C}/\text{W}$, $V_I = 5 \text{ V}$, $T_J = 150^\circ\text{C}$, $T_A = 25^\circ\text{C}$ (QSOP16)	-	-	223.2	
	$R_{\theta JA} = 93^\circ\text{C}/\text{W}$, $V_I = 5 \text{ V}$, $T_J = 150^\circ\text{C}$, $T_A = 25^\circ\text{C}$ (WSOP16)	-	-	268.8	
Safety Total Power	$R_{\theta JA} = 79^\circ\text{C}/\text{W}$, $T_J = 150^\circ\text{C}$, $T_A = 25^\circ\text{C}$ (SOP16)	-	-	1582.2	mW
	$R_{\theta JA} = 112^\circ\text{C}/\text{W}$, $T_J = 150^\circ\text{C}$, $T_A = 25^\circ\text{C}$ (QSOP16)	-	-	1116.0	
	$R_{\theta JA} = 93^\circ\text{C}/\text{W}$, $T_J = 150^\circ\text{C}$, $T_A = 25^\circ\text{C}$ (WSOP16)	-	-	1344	
Maximum Safety Temperature		-	-	150	°C

(1) The assumed junction-to-air thermal resistance in the Thermal Information is that of a device installed on a high-K test board for leaded surface-mount packages.

3-Channel Enhanced High-Performance Digital Isolator

Electrical Characteristics

All test condition is at $V_{CCA} = V_{CCB} = 2.25\text{ V}$ to 5.5 V , $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$, Typical value is in $V_{CC} = 3.3\text{ V}$, $T_A = +25^\circ\text{C}$, unless otherwise noted.

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Input Electrical Specifications						
V_{IH}	Logic Input High Voltage	Input signal, INx	2.0	-	-	V
V_{IL}	Logic Input Low Voltage	Input signal, INx	-	-	0.8	V
V_{IT+}	Rising Input Threshold Voltage	Input signal, INx	-	1.6	2	V
V_{IT-}	Falling Input Threshold Voltage	Input signal, INx	0.8	1.2	-	V
V_{HYS}	Input Threshold Voltage Hysteresis		-	0.4	-	V
I_{IH}	High-Level Input Current	$V_{IH} = V_{CCA}$ at INx ⁽¹⁾	-	2.5	10	μA
I_{IL}	Low-Level Input Current	$V_{IL} = 0\text{ V}$ at INx ⁽¹⁾	-10	-2.5	-	μA
I_{OH}	High-Level Output Current	$V_{CCB} = 5\text{ V} \pm 10\%$	-4	-	-	mA
		$V_{CCB} = 3.3\text{ V} \pm 10\%$	-2	-	-	
		$V_{CCB} = 2.5\text{ V} \pm 10\%$	-1	-	-	
I_{OL}	Low-Level Output Current	$V_{CCB} = 5\text{ V} \pm 10\%$	-	-	4	mA
		$V_{CCB} = 3.3\text{ V} \pm 10\%$	-	-	2	
		$V_{CCB} = 2.5\text{ V} \pm 10\%$	-	-	1	
V_{OH}	High-Level Output Voltage	$V_{CCB} = 5\text{ V} \pm 10\%$, $I_{OH} = -4\text{ mA}$; Test OUTx	$V_{CCB} = 0.4$	$V_{CCB} = 0.2$	-	V
		$V_{CCB} = 3.3\text{ V} \pm 10\%$, $I_{OH} = -2\text{ mA}$; Test OUTx	$V_{CCB} = 0.3$	$V_{CCB} = 0.15$	-	
		$V_{CCB} = 2.5\text{ V} \pm 10\%$, $I_{OH} = -1\text{ mA}$; Test OUTx	$V_{CCB} = 0.2$	$V_{CCB} = 0.1$	-	
V_{OL}	Low-Level Output Voltage	$V_{CCB} = 5\text{ V} \pm 10\%$, $I_{OL} = 4\text{ mA}$; Test OUTx	-	0.2	0.4	V
		$V_{CCB} = 3.3\text{ V} \pm 10\%$, $I_{OL} = 2\text{ mA}$; Test OUTx	-	0.15	0.3	
		$V_{CCB} = 2.5\text{ V} \pm 10\%$, $I_{OL} = 1\text{ mA}$; Test OUTx	-	0.1	0.2	
CMTI	Common-Mode Transient Immunity	Static CMTI	150	200	-	$\text{kV}/\mu\text{s}$
		Dynamic CMTI	100	150	-	$\text{kV}/\mu\text{s}$
C_i	Input Capacitance (1)		-	2	-	pF

(1) Provided by bench test and design simulation

3-Channel Enhanced High-Performance Digital Isolator

Timing Specifications – 5-V Supply

All test condition is at $V_{CCA} = V_{CCB} = 5 \text{ V} \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Typical value is in $V_{CC} = 5 \text{ V}$, $T_A = +25^\circ\text{C}$, $C_L = 15 \text{ pF}$ to GND, unless otherwise noted.

Parameter		Conditions	Min	Typ	Max	Unit
f_{DATA}	Translation data rate		-	-	150	Mpbs
t_{PLH}	Propagation delay time		-	11.5	22	ns
t_{PHL}	Propagation delay time		-	12	22	ns
PWD	Pulse width distortion ⁽¹⁾ $ t_{PHL} - t_{PLH} $		-	0.5	5	ns
$t_{sk(CC)}$	Channel-to-channel output skew time ⁽¹⁾⁽²⁾	Same direction channels	-	-	2.5	ns
$t_{sk(PP)}$	Channel-to-channel output skew time ⁽¹⁾⁽²⁾	Same direction channels	-	-	4.5	ns
t_r	Output signal rise time ⁽¹⁾		-	0.7	4	ns
t_f	Output signal fall time ⁽¹⁾		-	0.7	4	ns
t_{PHZ}	Disable propagation delay, high-to-high impedance output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	20	40	ns
t_{PLZ}	Disable propagation delay, low-to-high impedance output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	18	40	ns
t_{PZH}	Enable propagation delay, high impedance-to-high output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	10.4	40	ns
t_{PZL}	Enable propagation delay, high impedance-to-low output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	8.6	40	ns
Jitter	Eye jitter p-p ⁽¹⁾	$f_{data} = 100 \text{ Mbps}$	-	340		ps
t_{DO}	Default output delay time from input power loss	Measured from the time V_{CC} goes below 1.7 V	-	30	80	ns
t_{SU}	Setup time		-	28	80	us
t_{ie}	Time interval error ⁽¹⁾	$2^{16} - 1$ PRBS data at 100 Mbps ⁽¹⁾	-	2.4	-	ns

(1) Provided by bench test and design simulation.

(2) $t_{sk(CC)}$ & $t_{sk(PP)}$ is the skew of delay time between the different channels of a single device or different devices switching in the same direction while operating at identical supply voltages, temperature, input signals, and loads.

3-Channel Enhanced High-Performance Digital Isolator
Supply Current Characteristics – 5-V Supply

All test condition is at $V_{CCA} = V_{CCB} = 5 \text{ V} \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Typical value is in $V_{CC} = 5 \text{ V}$, $T_A = +25^\circ\text{C}$, $C_L = 15 \text{ pF}$ to GND, unless otherwise noted.

Parameter	Description	Supply Current	Min	Typ	Max	Unit
TPT7730						
Supply current - DC signal	$V_I = 0 \text{ V}(\text{TPT773xF})$ $V_I = VCC_I(\text{TPT773x})$	I _{CCA}	-	2.4	3.9	mA
		I _{CCB}	-	4.3	6.3	
Supply current - AC signal	$V_I = VCC_I(\text{TPT773xF})$ $V_I = 0 \text{ V}(\text{TPT773x})$	I _{CCA}	-	12.0	12.3	mA
		I _{CCB}	-	7.0	10.3	
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15 \text{ pF}$	1 Mbps	I _{CCA}	-	7.3	8.2
			I _{CCB}	-	5.9	8.4
		10 Mbps	I _{CCA}	-	8.9	9.0
			I _{CCB}	-	7.9	10.0
		100 Mbps	I _{CCA} ⁽¹⁾	-	11.9	15.2
			I _{CCB} ⁽¹⁾	-	22	24.4
TPT7731						
Supply current - DC signal	$V_I = 0 \text{ V}(\text{TPT773xF})$ $V_I = VCC_I(\text{TPT773x})$	I _{CCA}	-	2.4	3.9	mA
		I _{CCB}	-	4.3	6.3	
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15 \text{ pF}$	1 Mbps	I _{CCA}	-	12.0	12.3
			I _{CCB}	-	7.0	10.3
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15 \text{ pF}$	10 Mbps	I _{CCA}	-	7.3	8.2
			I _{CCB}	-	5.9	8.4
		100 Mbps	I _{CCA}	-	8.9	9.0
			I _{CCB}	-	7.9	10.0
		⁽¹⁾	I _{CCA} ⁽¹⁾	-	11.9	15.2
			I _{CCB} ⁽¹⁾	-	22	24.4

(1) Provided by bench test and design simulation.

(2) VCC_I is the VCC of V_I .

3-Channel Enhanced High-Performance Digital Isolator

Timing Specifications – 3.3-V Supply

All test condition is at $V_{CCA} = V_{CCB} = 3.3\text{ V} \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Typical value is in $V_{CC} = 3.3\text{ V}$, $T_A = +25^\circ\text{C}$, $C_L = 15\text{ pF}$ to GND, unless otherwise noted.

Parameter		Conditions	Min	Typ	Max	Unit
f_{DATA}	Translation data rate		-	-	150	Mpbs
t_{PLH}	Propagation delay time		-	12.5	22	ns
t_{PHL}	Propagation delay time		-	12.2	22	ns
PWD	Pulse width distortion ⁽¹⁾ $ t_{PHL} - t_{PLH} $		-	0.3	5	ns
$t_{sk(CC)}$	Channel-to-channel output skew time ⁽¹⁾⁽²⁾	Same direction channels	-	-	2.5	ns
$t_{sk(PP)}$	Channel-to-channel output skew time ⁽¹⁾⁽²⁾	Same direction channels	-	-	4.5	ns
t_r	Output signal rise time ⁽¹⁾		-	0.7	4	ns
t_f	Output signal fall time ⁽¹⁾		-	0.7	4	ns
t_{PHZ}	Disable propagation delay, high-to-high impedance output	$C_L = 15\text{ pF}, R_L = 1\text{ K}$	-	20	40	ns
t_{PLZ}	Disable propagation delay, low-to-high impedance output	$C_L = 15\text{ pF}, R_L = 1\text{ K}$	-	18.5	40	ns
t_{PZH}	Enable propagation delay, high impedance-to-high output	$C_L = 15\text{ pF}, R_L = 1\text{ K}$	-	14.9	40	ns
t_{PZL}	Enable propagation delay, high impedance-to-low output	$C_L = 15\text{ pF}, R_L = 1\text{ K}$	-	13.5	40	ns
Jitter	Eye jitter p-p ⁽¹⁾	$f_{data} = 100\text{ Mbps}$	-	340	-	ps
t_{DO}	Default output delay time from input power loss	Measured from the time V_{CC} goes below 1.7 V.	-	30	80	ns
t_{SU}	Setup time		-	28	80	us
t_{ie}	Time interval error ⁽¹⁾	$2^{16} - 1$ PRBS data at 100 Mbps (1)	-	2.4	-	ns

(1) Provided by bench test and design simulation.

(2) $t_{sk(CC)}$ & $t_{sk(PP)}$ is the skew of delay time between the different channels of a single device or different devices switching in the same direction while operating at identical supply voltages, temperature, input signals, and loads.

3-Channel Enhanced High-Performance Digital Isolator
Supply Current Characteristics – 3.3-V Supply

All test condition is at $V_{CCA} = V_{CCB} = 3.3\text{ V} \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Typical value is in $V_{CC} = 3.3\text{ V}$, $T_A = +25^\circ\text{C}$, $C_L = 15\text{ pF}$ to GND, unless otherwise noted.

Parameter	Description	Supply Current	Min	Typ	Max	Unit
TPT7730						
Supply current - DC signal	$V_I = 0\text{ V}(\text{TPT773xF})$	I_{CCA}	-	2.7	3.8	mA
	$V_I = V_{CC_I}(\text{TPT773x})$	I_{CCB}	-	4.3	6.2	
Supply current - AC signal	$V_I = V_{CC_I}(\text{TPT773xF})$	I_{CCA}	-	12.0	12.0	mA
	$V_I = 0\text{ V}(\text{TPT773x})$	I_{CCB}	-	6.9	10.1	
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15\text{ pF}$	I_{CCA}	-	7.2	8.2	
		I_{CCB}	-	5.7	8.2	
		I_{CCA}	-	8.4	8.3	
		I_{CCB}	-	7.1	9.1	
		$I_{CCA}^{(1)}$	-	10.7	14.8	
		$I_{CCB}^{(1)}$	-	15.4	21.3	
TPT7731						
Supply current - DC signal	$V_I = 0\text{ V}(\text{TPT773xF})$	I_{CCA}	-	2.7	3.8	mA
	$V_I = V_{CC_I}(\text{TPT773x})$	I_{CCB}	-	4.3	6.2	
Supply current - AC signal	$V_I = V_{CC_I}(\text{TPT773xF})$	I_{CCA}	-	12.0	12.0	
	$V_I = 0\text{ V}(\text{TPT773x})$	I_{CCB}	-	6.9	10.1	
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15\text{ pF}$	I_{CCA}	-	7.2	8.2	
		I_{CCB}	-	5.7	8.2	
		I_{CCA}	-	8.4	8.3	
		I_{CCB}	-	7.1	9.1	
		$I_{CCA}^{(1)}$	-	10.7	14.8	
		$I_{CCB}^{(1)}$	-	15.4	21.3	

(1) Provided by bench test and design simulation.

(2) V_{CC_I} is the V_{CC} of V_I .

3-Channel Enhanced High-Performance Digital Isolator

Timing Specifications – 2.5-V Supply

All test condition is at $V_{CCA} = V_{CCB} = 2.5 \text{ V} \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Typical value is in $V_{CC} = 2.5 \text{ V}$, $T_A = +25^\circ\text{C}$, $C_L = 15 \text{ pF}$ to GND, unless otherwise noted.

Parameter		Conditions	Min	Typ	Max	Unit
f_{DATA}	Translation data rate		-	-	150	Mpbs
t_{PLH}	Propagation delay time		-	13.5	22	ns
t_{PHL}	Propagation delay time		-	12.2	22	ns
PWD	Pulse width distortion ⁽¹⁾ $ t_{PHL} - t_{PLH} $		-	1.3	5	ns
$t_{sk(CC)}$	Channel-to-channel output skew time ⁽¹⁾⁽²⁾	Same direction channels	-	-	2.5	ns
$t_{sk(PP)}$	Channel-to-channel output skew time ⁽¹⁾⁽²⁾	Same direction channels	-	-	4.5	ns
t_r	Output signal rise time ⁽¹⁾		-	0.7	4	ns
t_f	Output signal fall time ⁽¹⁾		-	0.7	4	ns
t_{PHZ}	Disable propagation delay, high-to-high impedance output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	24.5	40	ns
t_{PLZ}	Disable propagation delay, low-to-high impedance output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	21.5	40	ns
t_{PZH}	Enable propagation delay, high impedance-to-high output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	20	40	ns
t_{PZL}	Enable propagation delay, high impedance-to-low output	$C_L = 15 \text{ pF}, R_L = 1 \text{ K}$	-	17.7	40	ns
Jitter	Eye jitter p-p ⁽¹⁾	$f_{data} = 100 \text{ Mbps}$	-	350	-	ps
t_{DO}	Default output delay time from input power loss	Measured from the time V_{CC} goes below 1.7 V.	-	30	80	ns
t_{SU}	Setup time		-	28	80	us
t_{ie}	Time interval error ⁽¹⁾	$2^{16} - 1$ PRBS data at 100 Mbps ⁽¹⁾	-	2.4	-	ns

(1) Provided by bench test and design simulation.

(2) $t_{sk(CC)}$ & $t_{sk(PP)}$ is the shew of delay time between different channels of a single device or different devices switching in the same direction while operating at identical supply voltages, temperature, input signals, and loads.

3-Channel Enhanced High-Performance Digital Isolator
Supply Current Characteristics – 2.5-V Supply

All test condition is at $V_{CCA} = V_{CCB} = 2.5 \text{ V} \pm 10\%$, $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$. Typical value is in $V_{CC} = 2.5 \text{ V}$, $T_A = +25^\circ\text{C}$, $C_L = 15 \text{ pF}$ to GND, unless otherwise noted.

Parameter	Description	Supply Current	Min	Typ	Max	Unit
TPT7730						
Supply current - DC signal	$V_I = 0 \text{ V}(\text{TPT773xF})$	I _{CCA}	-	2.7	3.8	mA
	$V_I = V_{CC_I}(\text{TPT773x})$	I _{CCB}	-	4.3	6.2	
Supply current - AC signal	$V_I = V_{CC_I}(\text{TPT773xF})$	I _{CCA}	-	11.9	12.0	mA
	$V_I = 0 \text{ V}(\text{TPT773x})$	I _{CCB}	-	6.9	9.6	
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15 \text{ pF}$	1 Mbps	I _{CCA}	-	7.2	7.8
			I _{CCB}	-	5.7	8.0
		10 Mbps	I _{CCA}	-	8.2	8.1
			I _{CCB}	-	6.8	8.8
		100 Mbps	I _{CCA} ⁽¹⁾	-	10.9	15.1
			I _{CCB} ⁽¹⁾	-	13.4	18.6
TPT7731						
Supply current - DC signal	$V_I = 0 \text{ V}(\text{TPT773xF})$	I _{CCA}	-	2.7	3.8	mA
	$V_I = V_{CC_I}(\text{TPT773x})$	I _{CCB}	-	4.3	6.2	
Supply current - AC signal	$V_I = V_{CC_I}(\text{TPT773xF})$	I _{CCA}	-	11.9	12.0	mA
	$V_I = 0 \text{ V}(\text{TPT773x})$	I _{CCB}	-	6.9	9.6	
Supply current - AC signal	All channels switching with square wave clock input; $C_L = 15 \text{ pF}$	1 Mbps	I _{CCA}	-	7.2	7.8
			I _{CCB}	-	5.7	8.0
		10 Mbps	I _{CCA}	-	8.2	8.1
			I _{CCB}	-	6.8	8.8
		100 Mbps	I _{CCA} ⁽¹⁾	-	10.9	15.1
			I _{CCB} ⁽¹⁾	-	13.4	18.6

(1) Provided by bench test and design simulation.

(2) V_{CC_I} is the V_{CC} of V_I .

3-Channel Enhanced High-Performance Digital Isolator

Test Circuits and Waveforms

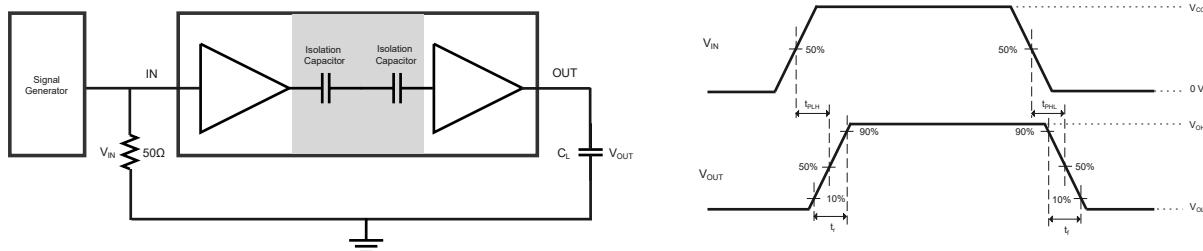


Figure 1. Swtching Characteristics Test circuit and Waveforms

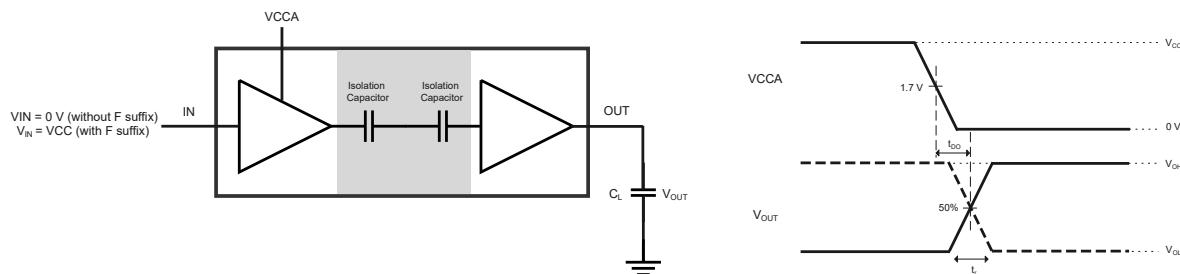


Figure 2. Default Output Delay Time Test Circuit and Voltage Waveforms

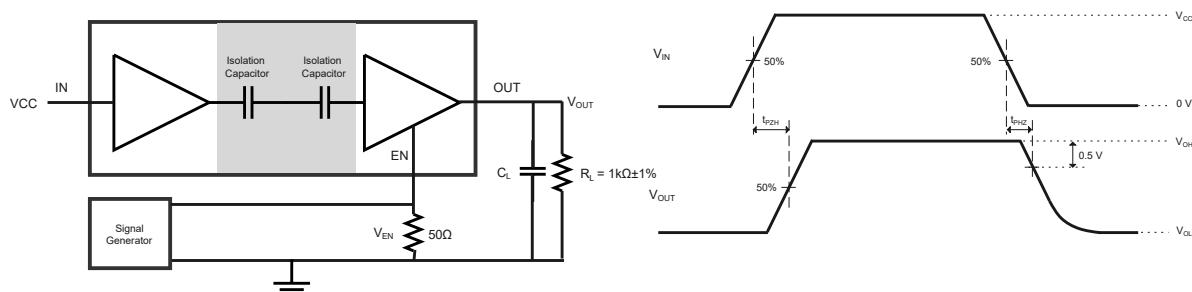
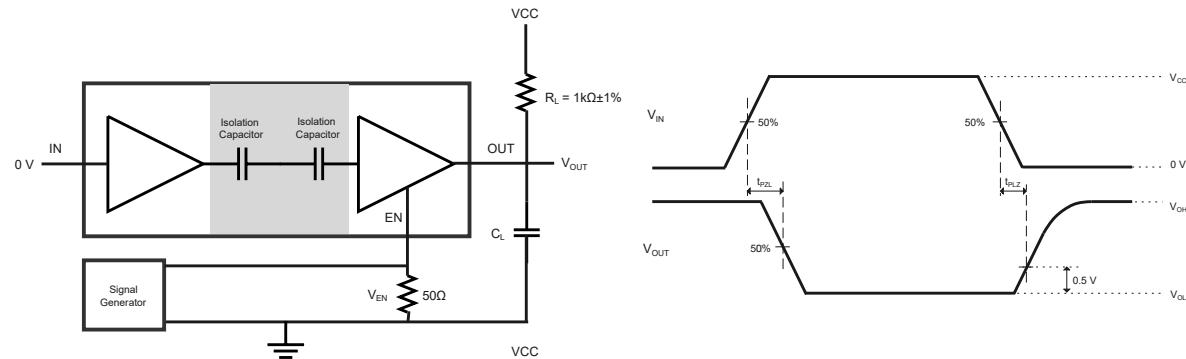
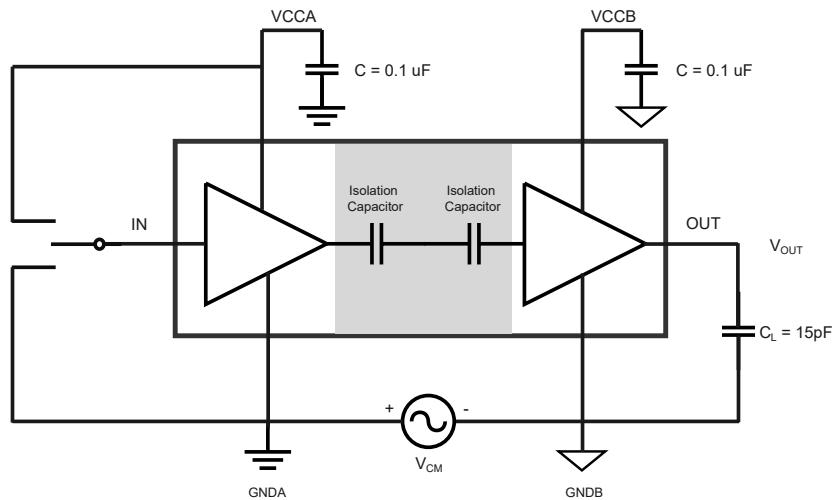


Figure 3. Enable/Disable propagation delay Test circuit and Waveforms

3-Channel Enhanced High-Performance Digital Isolator**Figure 4. Common-Mode Transient Immunity Test Circuit**

3-Channel Enhanced High-Performance Digital Isolator

Detailed Description

Overview

The TPT773x family utilize an ON-OFF Keying (OOK) modulation circuit to transmit the digital data through the isolation barrier. The transmitter sends a RF carrier to represent digital state one and sends no signal to represent the digital state zero. The devices also utilize advanced circuit design to maximise CMTI performance and minimise radiated emissions. The block diagram below shows a functional block diagram of a typical channel.

Functional Block Diagram

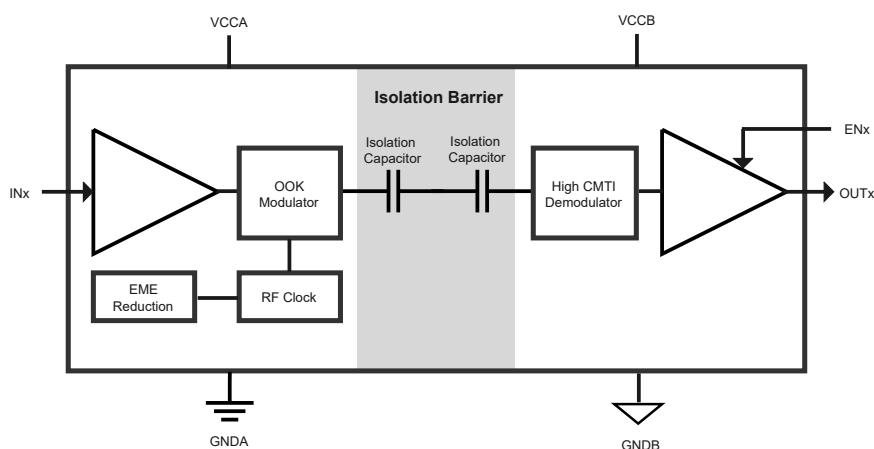


Figure 5. Block Diagram of Digital Capacitive Isolator

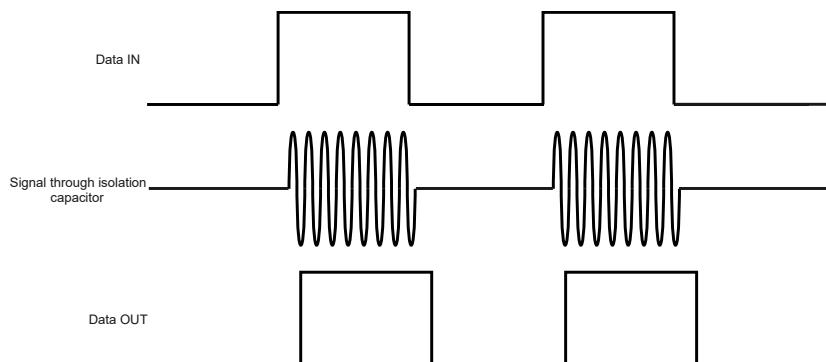


Figure 6. On-Off Keying (OOK) based Modulation Scheme

3-Channel Enhanced High-Performance Digital Isolator

Feature Description

The TPT773x family of devices is available in two-channel configurations and default output state options to enable a variety of application uses. The table below lists the device features of the TPT773x devices.

Part Number	Max Data rate	Channel Direction	Default Output State	Package	Rating Isolation
TPT7730	150 Mbps	4 Forward, 0 Reverse	High	WSOP16	5000 V _{RMS} / 7070 V _{PK}
				QSOP16	3750 V _{RMS} / 5300 V _{PK}
				SOP16	3750 V _{RMS} / 5300 V _{PK}
TPT7730F	150 Mbps	4 Forward, 0 Reverse	Low	WSOP16	5000 V _{RMS} / 7070 V _{PK}
				QSOP16	3750 V _{RMS} / 5300 V _{PK}
				SOP16	3750 V _{RMS} / 5300 V _{PK}
TPT7731	150 Mbps	3 Forward, 1 Reverse	High	WSOP16	5000 V _{RMS} / 7070 V _{PK}
				QSOP16	3750 V _{RMS} / 5300 V _{PK}
				SOP16	3750 V _{RMS} / 5300 V _{PK}
TPT7731F	150 Mbps	3 Forward, 1 Reverse	Low	WSOP16	5000 V _{RMS} / 7070 V _{PK}
				QSOP16	3750 V _{RMS} / 5300 V _{PK}
				SOP16	3750 V _{RMS} / 5300 V _{PK}

3-Channel Enhanced High-Performance Digital Isolator

Device Functional Modes

The below table lists the functional modes for the TPT773x devices.

VCC _I	VCC _O	Input (INx)	Enable (ENA, ENB)	Output (OUTx)	Comments
Power up	Power up	High	High or Open	High	Normal Operation
		Low	High or Open	Low	
		Open	High or Open	Default	Default mode. The default is High for TPT773x and Low for TPT773xF
X	Power up	X	Low	Z	Disabled output is high impedance
Power down	Power up	X	High or Open	Default	Default mode. When VCC _I is unpowered, the default is High for TPT773x and Low for TPT773xF
X	Power down	X	X	Undetermined	When VCC _O is unpowered, a channel output is undetermined.

(1) VCC_I = Input-side V_{CCA}; VCC_O = Output-side V_{CCB}; Powered up (V_{CC} ≥ 2.25 V); Powered down (V_{CC} ≤ 1.7 V);

(2) X = Irrelevant; Z = High impedance

(3) The outputs are in the undetermined state when 1.7 V < VCC_I, VCC_O < 2.25 V.

3-Channel Enhanced High-Performance Digital Isolator

Application and Implementation

Note

Information in the following application sections is not part of the 3PEAK's component specification and 3PEAK does not warrant its accuracy or completeness. 3PEAK's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

Typical Application

Figure 7 is the TPT773x typical application. The two external bypass capacitors need to be close to the VCC power pin. The maximum distance is 2 mm.

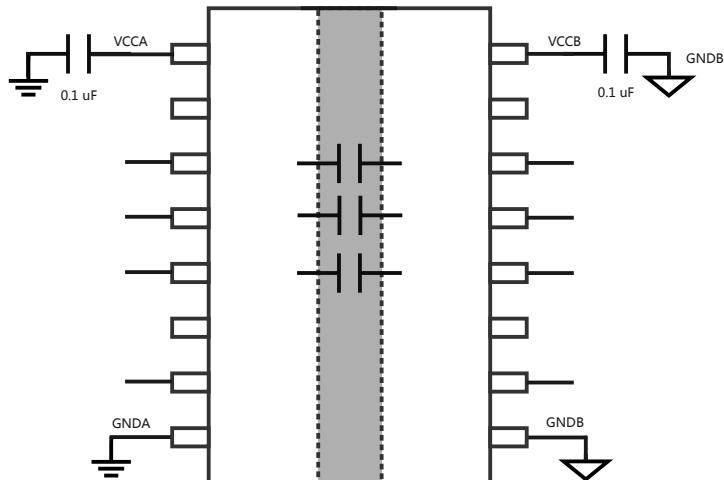
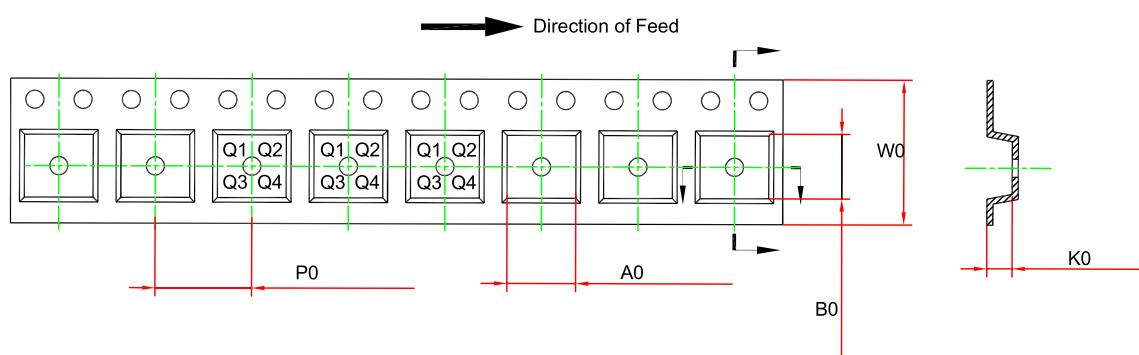
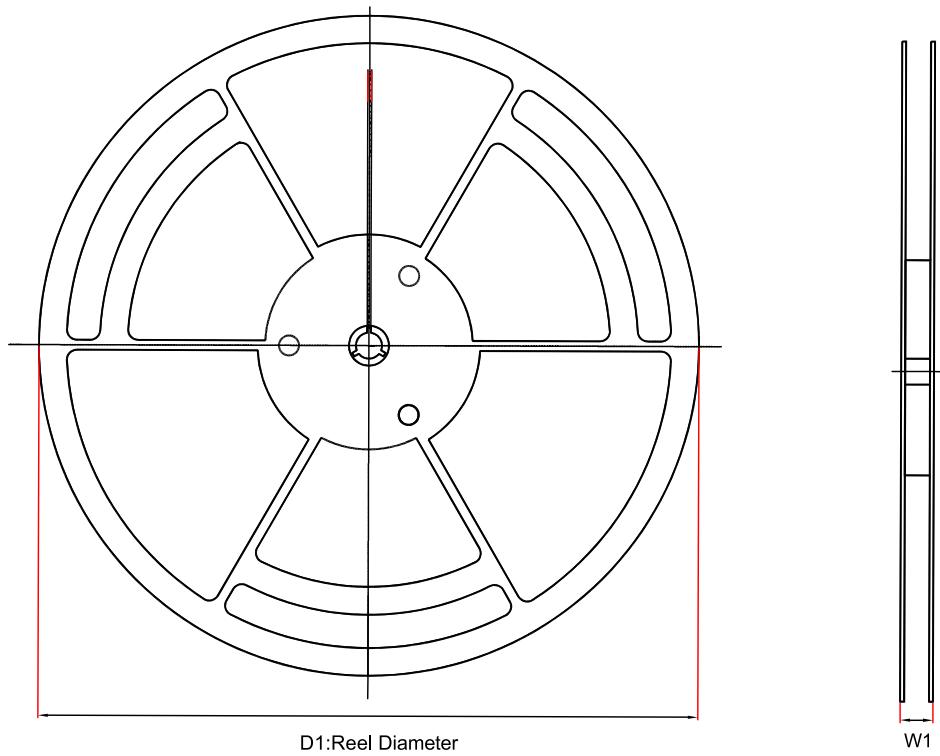


Figure 7. Typical Application

3-Channel Enhanced High-Performance Digital Isolator
Tape and Reel Information


Order Number	Package	D1 (mm)	W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	W0 (mm)	Pin1 Quadrant
TPT7730-SO3R	SOP16	330	21.6	6.7	10.4	2.1	8.0	16.0	Q1
TPT7730F-SO3R	SOP16	330	21.6	6.7	10.4	2.1	8.0	16.0	Q1
TPT7731-SO3R	SOP16	330	21.6	6.7	10.4	2.1	8.0	16.0	Q1
TPT7731F-SO3R	SOP16	330	21.6	6.7	10.4	2.1	8.0	16.0	Q1
TPT7730-SSAR	QSOP16	330	17.6	6.4	5.4	2.1	8.0	12.0	Q1
TPT7730F- SSAR	QSOP16	330	17.6	6.4	5.4	2.1	8.0	12.0	Q1
TPT7731- SSAR	QSOP16	330	17.6	6.4	5.4	2.1	8.0	12.0	Q1



TPT773x

3-Channel Enhanced High-Performance Digital Isolator

Order Number	Package	D1 (mm)	W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P0 (mm)	W0 (mm)	Pin1 Quadrant
TPT7731F- SSAR	QSOP16	330	17.6	6.4	5.4	2.1	8.0	12.0	Q1
TPT7730-SOBR	WSOP16	330	22.4	10.9	10.8	3.0	12.0	16.0	Q1
TPT7730F-SOBR	WSOP16	330	22.4	10.9	10.8	3.0	12.0	16.0	Q1
TPT7731-SOBR	WSOP16	330	22.4	10.9	10.8	3.0	12.0	16.0	Q1
TPT7731F-SOBR	WSOP16	330	22.4	10.9	10.8	3.0	12.0	16.0	Q1

3-Channel Enhanced High-Performance Digital Isolator
Package Outline Dimensions
SOP16

Package Outline Dimensions		SO3(SOP-16-A)			
Symbol	Dimensions In Millimeters		Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	1.350	1.750	0.053	0.069	
A1	0.050	0.250	0.002	0.010	
A2	1.300	1.600	0.051	0.063	
b	0.330	0.510	0.013	0.020	
c	0.170	0.250	0.007	0.010	
D	9.800	10.000	0.386	0.394	
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
e	1.270 BSC		0.050 BSC		
L	0.400	1.000	0.016	0.039	
θ	0	8°	0	8°	

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

3-Channel Enhanced High-Performance Digital Isolator
QSOP16

Package Outline Dimensions		SSA(QSOP-16-A)			
Symbol	Dimensions In Millimeters		Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	1.350	1.750	0.053	0.069	
A1	0.050	0.250	0.002	0.010	
A2	1.300	1.500	0.051	0.059	
b	0.230	0.310	0.009	0.012	
c	0.170	0.250	0.007	0.010	
D	4.800	5.000	0.189	0.197	
E	5.800	6.200	0.228	0.244	
E1	3.800	4.000	0.150	0.157	
e	0.635 BSC		0.025 BSC		
L	0.400	0.800	0.016	0.031	
θ	0	8°	0	8°	

NOTES

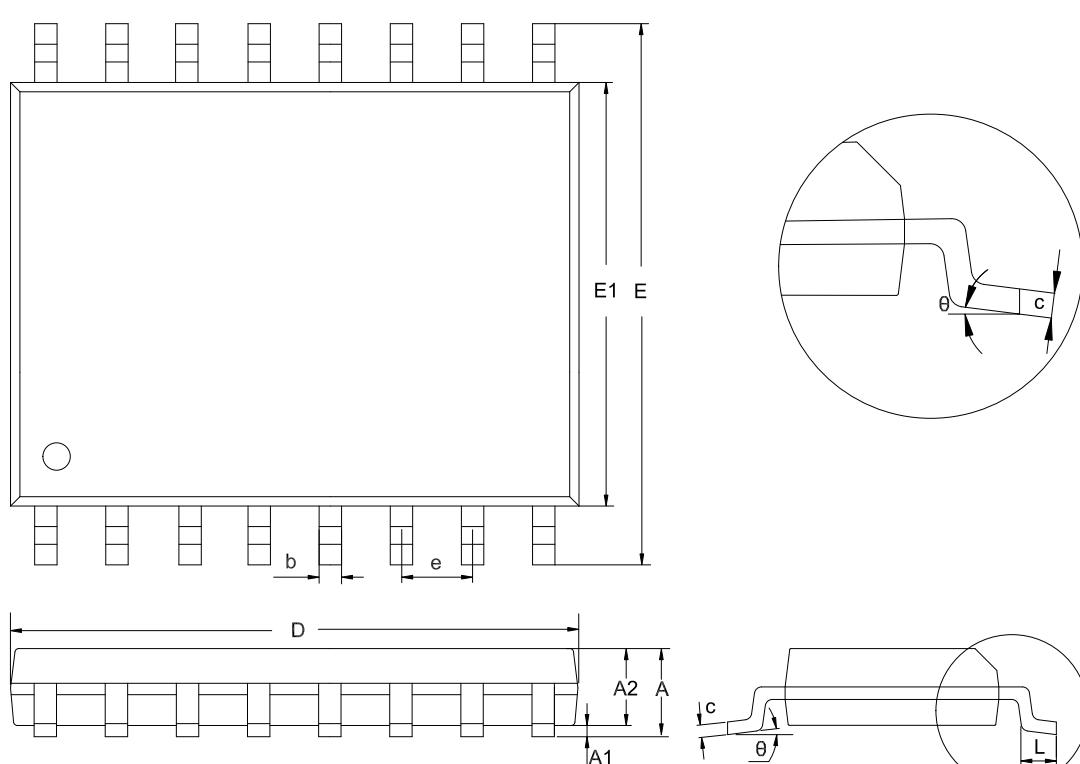
1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.

3-Channel Enhanced High-Performance Digital Isolator
WSOP16

Package Outline Dimensions		SOB(WSOP-16-A)			
Symbol	Dimensions In Millimeters		Dimensions In Inches		
	MIN	MAX	MIN	MAX	
A	2.350	2.650	0.093	0.104	
A1	0.100	0.300	0.004	0.012	
A2	2.250	2.350	0.089	0.093	
b	0.350	0.450	0.014	0.018	
c	0.200	0.290	0.008	0.011	
D	10.100	10.500	0.398	0.413	
E	10.100	10.600	0.398	0.417	
E1	7.300	7.700	0.287	0.303	
e	1.270 BSC		0.050 BSC		
L	0.500	0.850	0.020	0.033	
θ	0	8°	0	8°	

NOTES

1. Do not include mold flash or protrusion.
2. This drawing is subject to change without notice.



3-Channel Enhanced High-Performance Digital Isolator

Order Information

Order Number	Operating Temperature Range	Package	Marking Information	MSL	Transport Media, Quantity	Eco Plan
TPT7730-SO3R	-40 to 125°C	16-Pin SOP	T7730	MSL3	Tape and Reel, 2500	Green
TPT7730F-SO3R	-40 to 125°C	16-Pin SOP	7730F	MSL3	Tape and Reel, 2500	Green
TPT7731-SO3R	-40 to 125°C	16-Pin SOP	T7731	MSL3	Tape and Reel, 2500	Green
TPT7731F-SO3R	-40 to 125°C	16-Pin SOP	7731F	MSL3	Tape and Reel, 2500	Green
TPT7730-SSAR	-40 to 125°C	16-Pin QSOP	T7730	MSL3	Tape and Reel, 1500	Green
TPT7730F-SSAR	-40 to 125°C	16-Pin QSOP	7730F	MSL3	Tape and Reel, 1500	Green
TPT7731-SSAR	-40 to 125°C	16-Pin QSOP	T7731	MSL3	Tape and Reel, 1500	Green
TPT7731F-SSAR	-40 to 125°C	16-Pin QSOP	7731F	MSL3	Tape and Reel, 1500	Green
TPT7730-SOBR	-40 to 125°C	16-Pin WSOP	T7730	MSL3	Tape and Reel, 1500	Green
TPT7730F-SOBR	-40 to 125°C	16-Pin WSOP	7730F	MSL3	Tape and Reel, 1500	Green
TPT7731-SOBR	-40 to 125°C	16-Pin WSOP	T7731	MSL3	Tape and Reel, 1500	Green
TPT7731F-SOBR	-40 to 125°C	16-Pin WSOP	7731F	MSL3	Tape and Reel, 1500	Green

Green: 3PEAK defines "Green" to mean RoHS compatible and free of halogen substances.

3-Channel Enhanced High-Performance Digital Isolator

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